



EC Declaration of Conformity (DoC)

We

Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Declare that the DoC is issued under our sole responsibility and belongs to the following product(s):

Product Type:	Evaluation Kit
Model Number(s):	USB-TO-GPIO

The object of the declaration described above is in conformity with the relevant Union harmonization legislation:

EMC Directive 2014/30/EU

The following harmonized standards and technical specifications have been applied:

EN 61326-1:2013

Notified Body:

Notified Body:	Intertek Testing & Certification LTD
Notified Body Number	0359
Reference number of the certificate of notified body	0001406

Technical Compliance File Held by:

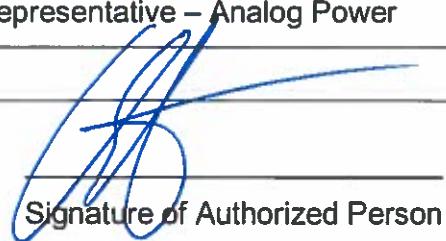
Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Signed for and on behalf of Texas Instruments Incorporated

Name:	Clay Peterson, Customer Quality Representative – Analog Power
Address:	12500 TI Blvd, Dallas, TX, 75243

Dallas, TX

6/8/2018

A blue ink signature of the name 'Clay Peterson'.

Place of issue

Date of issue

Signature of Authorized Person

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